

# **2019 IEEE International Flexible Electronics Technology Conference (IFETC 2019)**

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R1: Conference Registration

R2: Conference Registration

OR: Opening Remarks

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Electrical Engineering Division, Cambridge University, United Kingdom

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University of British Columbia, Canada

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Deputy General Director, ITRI

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Flexible Microsystems for On-Body Sensing and Measuring Tissue Integrated Sensors - Prof. Michael A. Daniele  
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National Research Council of Canada

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Binghamton University, USA

## B2: Coffee Break

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